

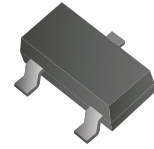
CJ3400-HF (N-Channel)

Reverse Voltage: 30 Volts

Forward Current: 5.8 A

RoHS Device

Halogen Free



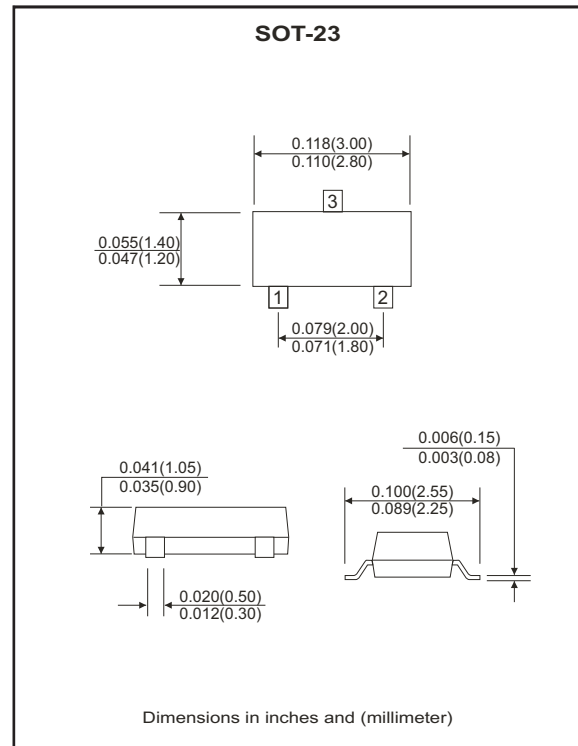
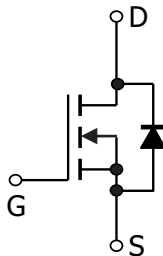
Features

- N-Channel Enhancement mode field effect transistor.
- High dense cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability.

Mechanical data

- Case: SOT-23, molded plastic.
- Terminals: solderable per MIL-STD-750, method 2026.

Circuit diagram



Maximum Ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Units
Drain-source voltage	V_{DS}	30	V
Gate-source voltage	V_{GS}	± 12	V
Continuous drain current	I_D	5.8	A
Drain current-pulsed (note 1)	I_{DM}	30	A
Power dissipation	P_D	350	mW
Thermal resistance from Junction to ambient (note 2)	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Junction temperature	T_J	150	$^\circ\text{C}$
Storage temperature	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (Ta=25 °C unless otherwise noted)

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source breakdown voltage	$V_{GS}=0V, I_D=250\mu A$	$V_{(BR)DSS}$	30			V
Zero gate voltage drain current	$V_{DS}=24V, V_{GS}=0V$	I_{DSS}			1	μA
Gate-Source leakage current	$V_{GS}=\pm 12V, V_{DS}=0V$	I_{GSS}			± 100	nA
On Characteristics						
Static drain-source on-resistance (note 3)	$V_{GS}=10V, I_D=5.8A$	$R_{DS(ON)}$			35	m Ω
	$V_{GS}=4.5V, I_D=5A$				40	
	$V_{GS}=2.5V, I_D=4A$				52	
Forward transconductance	$V_{DS}=5V, I_D=5A$	g_{FS}	8			S
Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	$V_{GS(th)}$	0.7		1.4	V
Dynamic Characteristics (note 3,4)						
Input capacitance	$V_{DS}=15V, V_{GS}=0V, f=1MHz$	C_{iss}			1050	pF
Output capacitance		C_{oss}		99		
Reverse transfer capacitance		C_{rss}		77		
Gate resistance	$V_{DS}=0V, V_{GS}=0V, f=1MHz$	R_g			3.6	Ω
Switching Characteristics (note 3,4)						
Turn-on delay time	$V_{GS}=10V, V_{DS}=15V, R_L=2.7\Omega, R_{GEN}=3\Omega$	$t_{d(on)}$			5	ns
Turn-on rise time		t_r			7	
Turn-off delay time		$t_{d(off)}$			40	
Turn-off Fall time		t_f			6	
Drain-source diode characteristics and maximum ratings						
Diode forward voltage (note 3)	$I_S=1A, V_{GS}=0V$	V_{SD}			1	V

Note:

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface mounted on FR4 Board, $t < 5sec$.
3. Pulse test; Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production testing.

RATING AND CHARACTERISTIC CURVES (CJ3400-HF)

Fig.1- Output Characteristics

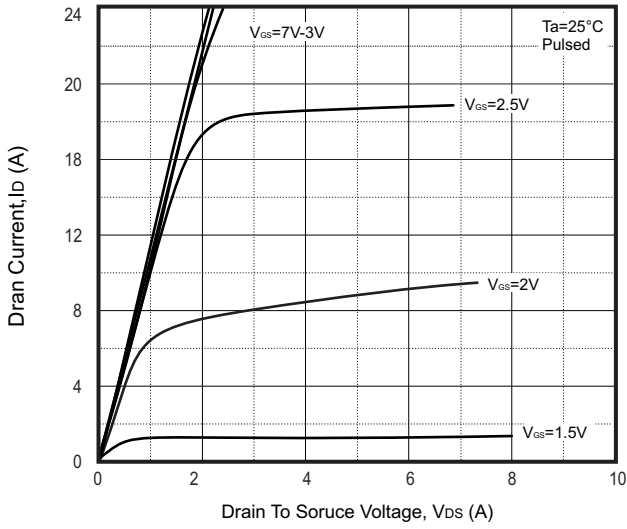


Fig.2- Transfer Characteristics

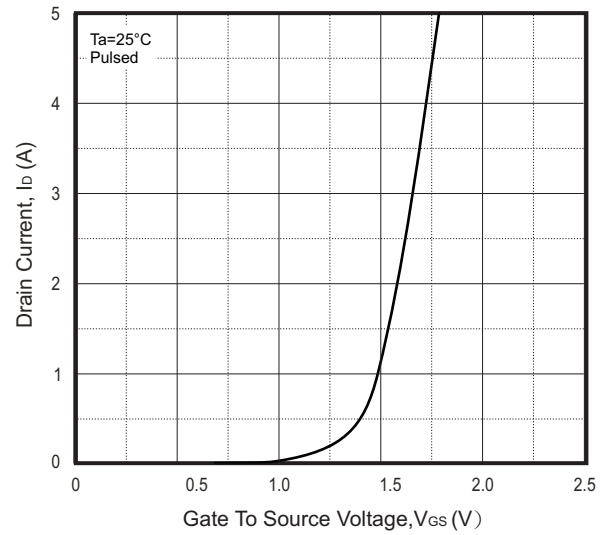


Fig.3- $R_{DS(ON)}$ — I_D

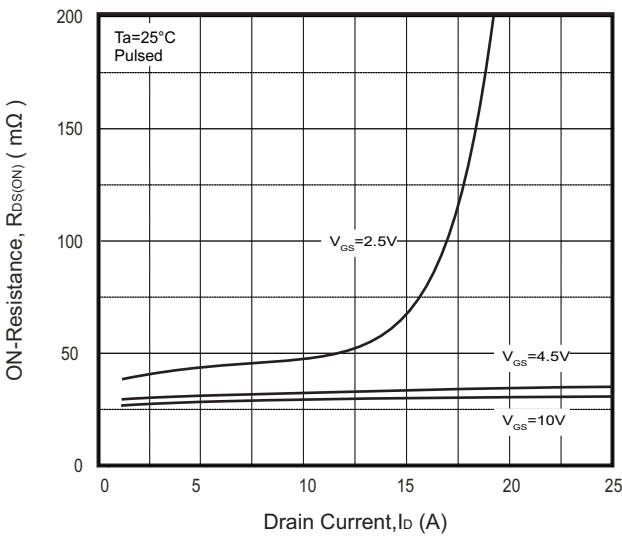


Fig.4- $R_{DS(ON)}$ — V_{GS}

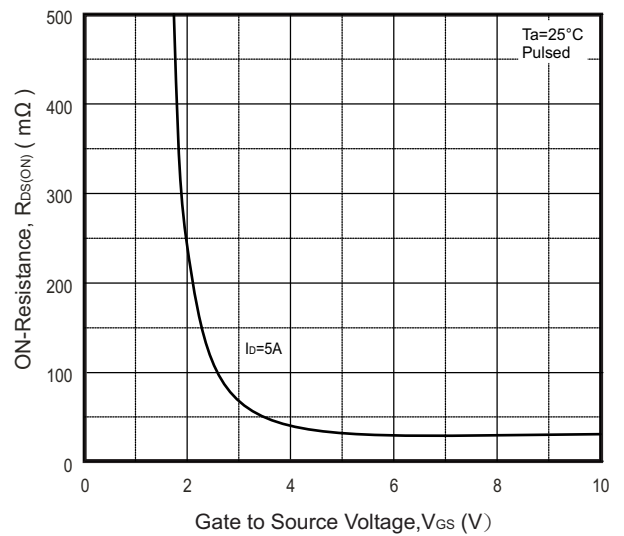
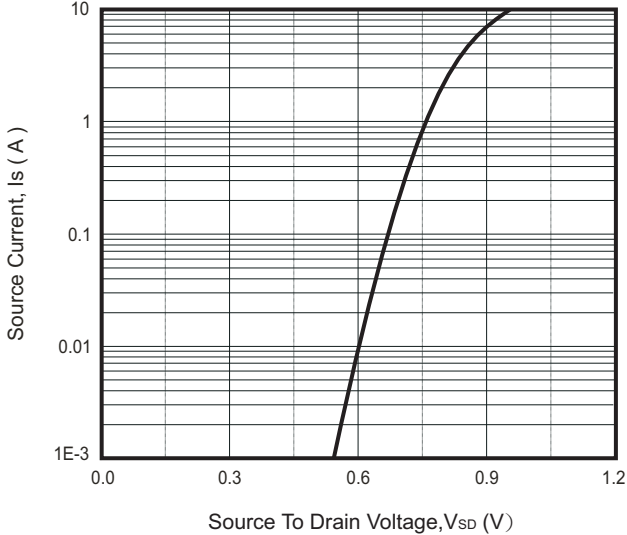


Fig.5 - I_S — V_{SD}

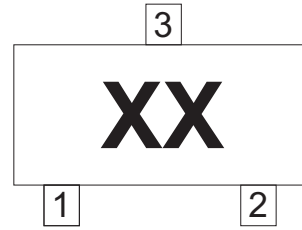


Company reserves the right to improve product design, functions and reliability without notice.

REV:A

Marking Code

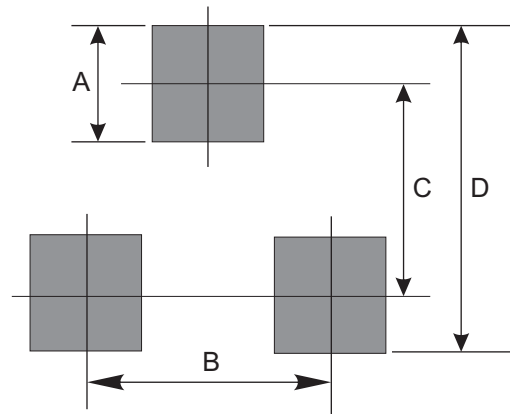
Part Number	Marking Code
CJ3400-HF	R0



xx = Product type marking code

Suggested PAD Layout

SIZE	SOT-23	
	(mm)	(inch)
A	0.80	0.031
B	1.90	0.075
C	2.02	0.080
D	2.82	0.111



Standard Packaging

Case Type	Qty Per Reel	Reel Size
	(Pcs)	(inch)
SOT-23	3,000	7